



# **SPECIFICATION**

(Reference sheet)

- Supplier : Samsung electro-mechanics - Samsung P/N : CL10C270JB8NFNC

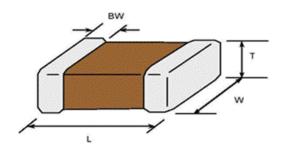
Product : Multi-layer Ceramic Capacitor
 Description : CAP, 27pF, 50V, ± 5%, C0G, 0603

### A. Samsung Part Number

<u>CL</u> <u>10</u> <u>C</u> <u>270</u> <u>J</u> <u>B</u> <u>8</u> <u>N</u> <u>F</u> <u>N</u> <u>C</u> ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

| 1 | Series        | Samsung Multi-layer Ceramic Capacitor |                   |                               |
|---|---------------|---------------------------------------|-------------------|-------------------------------|
| 2 | Size          | 0603 (inch code)                      | L: 1.60 ± 0.10 mm | W: 0.80 ± 0.10 mm             |
| 3 | Dielectric    | C0G                                   | Inner electrode   | Ni                            |
| 4 | Capacitance   | <b>27</b> pF                          | Termination       | Cu                            |
| ⑤ | Capacitance   | ± 5%                                  | Plating           | Sn 100% (Pb Free)             |
|   | tolerance     |                                       | Product           | Product for POWER application |
| 6 | Rated Voltage | 50 V                                  | Special           | Reserved for future use       |
| 7 | Thickness     | 0.80 ± 0.10 mm                        | ① Packaging       | Cardboard Type, 7" reel       |

#### B. Structure and dimension



| Samsung P/N     | Dimension(mm) |             |             |             |  |
|-----------------|---------------|-------------|-------------|-------------|--|
| (Lead Free)     | L             | W           | Т           | BW          |  |
| CL10C270JB8NFNC | 1.60 ± 0.10   | 0.80 ± 0.10 | 0.80 ± 0.10 | 0.30 ± 0.20 |  |

#### C. Samsung Reliability Test and Judgement condition

|                                       | Performance   | Test condition  |  |  |  |
|---------------------------------------|---|---|--|--|--|
| Capacitance                           | Within specified tolerance  | 1 <sup>Mlz</sup> ±10% / 0.5~5Vrms                           |  |  |  |
| Q 940 min                             |   | 7   |  |  |  |
| nsulation 10,000Mohm or 500Mohm×μF    |   | Rated Voltage 60~120 sec.                                   |  |  |  |
| Resistance                            | Whichever is smaller  |   |  |  |  |
| Appearance                            | No abnormal exterior appearance                                   | Microscop (X10)   |  |  |  |
| Withstanding                          | No dielectric breakdown or  | 300% of the rated voltage                                   |  |  |  |
| Voltage                               | mechanical breakdown  |   |  |  |  |
| Temperature C0G                       |   | -   |  |  |  |
| Characteristics                       | (From -55℃ to 125℃, Capacitance change should be within ±30PPM/℃) |   |  |  |  |
| Adhesive Strength                     | No peeling shall be occur on the                                  | 500g×F, for 10±1 sec.                                       |  |  |  |
| of Termination                        | terminal electrode  |   |  |  |  |
| Bending Strength                      | Capacitance change :  | Bending to the limit (1mm)                                  |  |  |  |
|                                       | within ±5% or ±0.5pF whichever is larger                          | with 1.0mm/sec.   |  |  |  |
| Solderability                         | More than 75% of terminal surface                                 | SnAg3.0Cu0.5 solder   |  |  |  |
|                                       | is to be soldered newly   | 245±5℃, 3±0.3sec.   |  |  |  |
|                                       |   | (preheating : 80~120 ℃ for 10~30sec.)                       |  |  |  |
|                                       |   |   |  |  |  |
| Resistance to                         | Capacitance change :  | Solder pot : 270±5℃, 10±1sec.                               |  |  |  |
| Soldering heat                        | within ±2.5% or ±0.25pF whichever is larger                       |   |  |  |  |
| _                                     | Tan δ, IR : initial spec.   |   |  |  |  |
| Vibration Test                        | Capacitance change :  | Amplitude : 1.5mm   |  |  |  |
|                                       | within ±2.5% or ±0.25pF whichever is larger                       | From 10Hz to 55Hz (return : 1min.)                          |  |  |  |
|                                       | Tan δ, IR : initial spec.   | 2hours ´ 3 direction (x, y, z)                              |  |  |  |
| Moisture                              | Capacitance change :  | With rated voltage  |  |  |  |
| Resistance                            | within ±7.5% or ±0.75pF whichever is larger                       | 40±2℃, 90~95%RH, 500+12/-0hrs                               |  |  |  |
|                                       | Q: 190 min  |   |  |  |  |
|                                       | IR: 500Mohm or 25Mohm × $\mu$ F                                   |   |  |  |  |
|                                       | Whichever is smaller  |   |  |  |  |
| High Temperature Capacitance change : |   | With 200% of the rated voltage                              |  |  |  |
| Resistance                            | within ±3% or ±0.3pF whichever is larger                          | Max. operating temperature                                  |  |  |  |
|                                       | Q: 342.5 min  | 1000+48/-0hrs   |  |  |  |
|                                       | IR: 1,000Mohm or 50Mohm × $\mu$ F                                 |   |  |  |  |
|                                       | Whichever is smaller  |   |  |  |  |
| Temperature                           | Capacitance change :  | 1 cycle condition   |  |  |  |
| Cycling                               | within ±2.5% or ±0.25pF whichever is larger                       | Min. operating temperature $\rightarrow$ 25 $^{\circ}$ C    |  |  |  |
| -                                     | Tan δ, IR : initial spec.   | $\rightarrow$ Max. operating temperature $\rightarrow$ 25°C |  |  |  |
|                                       | ·   |   |  |  |  |
|                                       |   |   |  |  |  |
|                                       |   | 5 cycle test  |  |  |  |

<sup>\*</sup> The reliability test condition can be replaced by the corresponding accelerated test condition.

#### D. Recommended Soldering method:

Reflow ( Reflow Peak Temperature : 260+0/-5 °C, 10sec. Max )



A Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

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Should you have any question regarding the product specifications,

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- ② Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- Military equipment
- 5 Disaster prevention/crime prevention equipment
- Any other applications with the same as or similar complexity or reliability to the applications set forth above.